

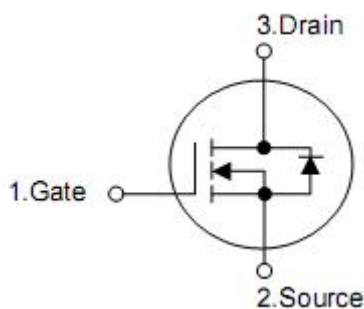
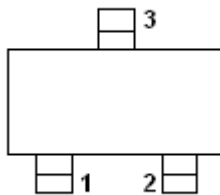
## 1. Description

The KIA3402 uses advanced trench technology to provide excellent  $R_{DS(on)}$ , low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a load switch or in PWM applications. KIA3402 (Green Product) is offered in a lead-free package.

## 2. Features

- n  $V_{DS}(V)=30V$
- n  $I_D=4.0A$
- n  $R_{DS(on)}<70m\Omega(V_{GS}=10V, I_D=4.0A)$
- n  $R_{DS(on)}<75m\Omega(V_{GS}=4.5V, I_D=2.3A)$
- n  $R_{DS(on)}<105m\Omega(V_{GS}=2.5V, I_D=1.5A)$

## 3. Symbol



Pin	Function
1	Gate
2	Source
3	Drain

#### 4. Absolute maximum ratings

( $T_A=25^\circ\text{C}$ , unless otherwise noted)

Parameter	Symbol	Rating	Units
Drain-source voltage	$V_{DS}$	30	V
Gate-source voltage	$V_{GS}$	$\pm 12$	V
Continuous drain current <sup>A</sup>	$I_D$	$T_A=25^\circ\text{C}$	4.0
		$T_A=70^\circ\text{C}$	3.4
Pulsed drain current <sup>B</sup>	$I_{DM}$	15	A
Total power dissipation <sup>A</sup>	$P_D$	$T_A=25^\circ\text{C}$	1.4
		$T_A=70^\circ\text{C}$	1
Junction and storage temperature range	$T_J, T_{STG}$	-55 to 150	$^\circ\text{C}$

#### 5. Thermal characteristics

Parameter	Symbol	Typ	Max	Unit
Maximum junction-ambient <sup>A</sup> ( $t \leq 10\text{s}$ )	$R_{\theta JA}$	70	90	$^\circ\text{C/W}$
Maximum junction-ambient <sup>A</sup>	$R_{\theta JA}$	100	125	$^\circ\text{C/W}$
Maximum junction-Lead <sup>C</sup>	$R_{\theta JL}$	63	80	$^\circ\text{C/W}$

## 6. Electrical characteristics

( $T_A=25^\circ\text{C}$ , unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Units
Drain-source breakdown voltage	$BV_{DSS}$	$V_{GS}=0V, I_D=250\mu A$	30	-	-	V
Zero gate voltage drain current	$I_{DSS}$	$V_{DS}=24V, V_{GS}=0V$	-	-	1	$\mu A$
Gate- body leakage current	$I_{GSS}$	$V_{GS}=\pm 12V, V_{DS}=0V$	-	-	100	nA
Gate threshold voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	0.8	1	1.6	V
On state drain current	$I_{D(on)}$	$V_{GS}=4.5V, V_{DS}=5V$	10	-	-	A
Static drain-source on-resistance	$R_{DS(on)}$	$V_{GS}=10V, I_D=4.0A$	-	-	70	m $\Omega$
		$V_{GS}=4.5V, I_D=2.3A$	-	-	75	
		$V_{GS}=2.5V, I_D=1.5A$	-	-	105	
Forward transconductance	$g_{fs}$	$V_{DS}=5.0V, I_D=4.0A$	-	8.0	-	S
Diode forward voltage	$V_{SD}$	$V_{GS}=0V, I_S=1A$	-	0.8	1.2	V
Maximum body-diode continuous current	$I_S$		-	-	2.5	A
Input capacitance	$C_{iss}$	$V_{DS}=15V, V_{GS}=0V,$ $f=1\text{MHz}$	-	390	-	pF
Output capacitance	$C_{oss}$		-	54.5	-	
Reverse transfer capacitance	$C_{rss}$		-	41	-	
Gate resistance	$R_g$	$V_{DS}=0V,$ $V_{GS}=0V, f=1\text{MHz}$	-	3	-	$\Omega$
Total gate charge	$Q_g$	$V_{DS}=15V, V_{GS}=4.5V$ $I_D=4.0A$	-	4.34	-	nC
Gate-source charge	$Q_{gs}$		-	0.6	-	
Gate-drain charge	$Q_{gd}$		-	1.38	-	
Turn-on delay time	$t_{d(on)}$	$V_{DS}=15V, R_L=3.75\Omega,$ $R_G=6\Omega, V_{GS}=10V$	-	3.3	-	ns
Rise time	$t_r$		-	1	-	
Turn-off delay time	$t_{d(off)}$		-	21.7	-	
Fall time	$t_f$		-	2.1	-	
Reverse recovery time	$t_{rr}$	$I_F=4.0A, di/dt=100A/\mu s,$	-	12	-	nS
Reverse recovery charge	$Q_{rr}$		-	6.3	-	nC

Note:A.The value of  $R_{\theta JA}$  is measured with the device mounted on 1 in<sup>2</sup> FR-4 board with 2oz.Copper,in a still air environment with  $T_A=25^\circ\text{C}$ .The value in any given application depends on the user's specific board design.The current rating is based on the  $t_{\leq 10s}$  thermal resistance rating.

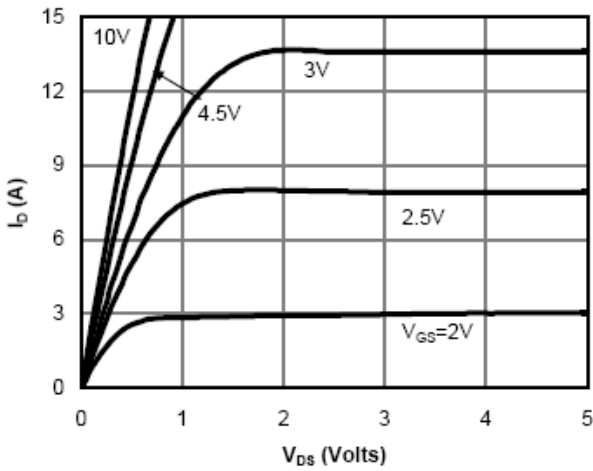
B.Repetitive rating,pulse width limited by junction temperature.

C.The  $R_{\theta JA}$  the sum of the thermal impedance from junction to lead  $R_{\theta JI}$  and lead to ambient.

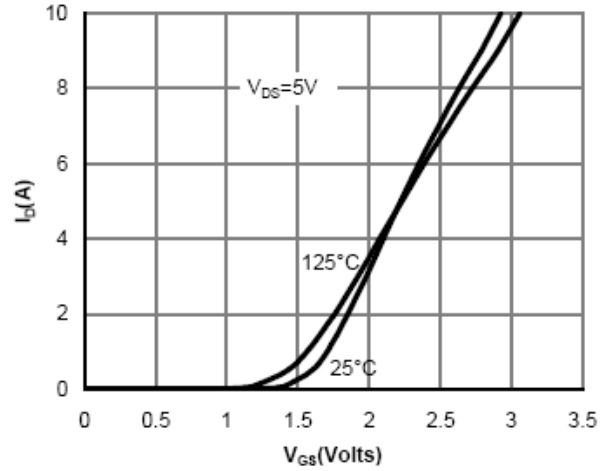
D.The static characteristics in Figures 1 to 6,12,14 are obtained using 80 $\mu s$  pulses,duty cycle 0.5% max.

E.These tests are performed with the device mounted on 1 in<sup>2</sup> FR-4 board with 2oz. Copper,in a still air environment with  $T_A=25^\circ\text{C}$ .The SOA curve provides a single pulse rating.

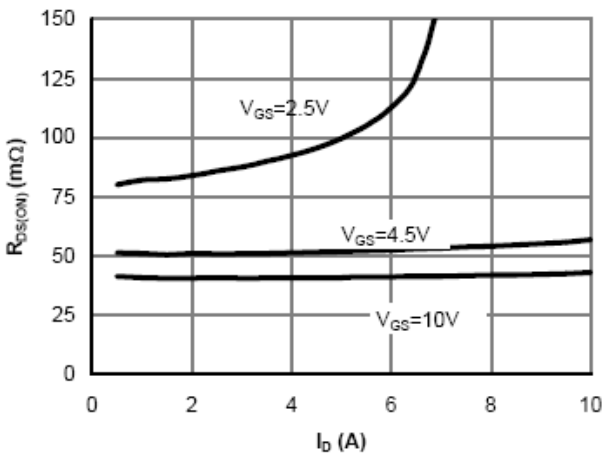
**7. Test circuits and waveforms**



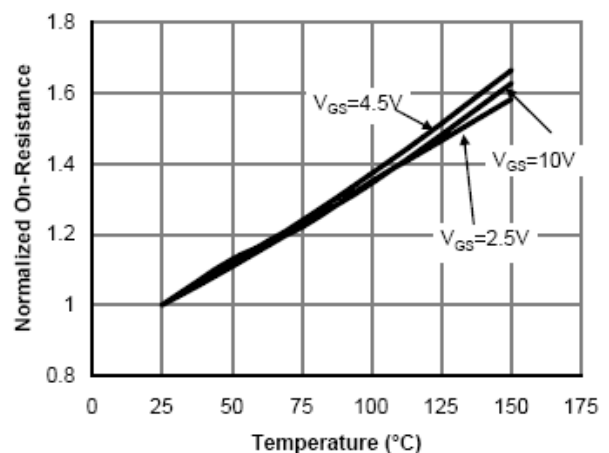
**Fig 1: On-Region Characteristics**



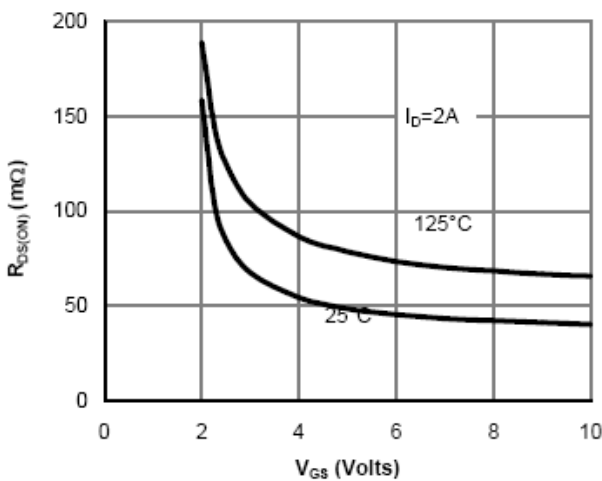
**Figure 2: Transfer Characteristics**



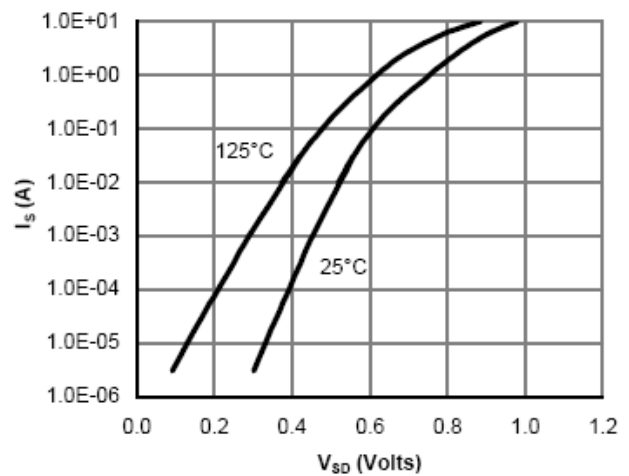
**Figure 3: On-Resistance vs. Drain Current and Gate Voltage**



**Figure 4: On-Resistance vs. Junction Temperature**



**Figure 5: On-Resistance vs. Gate-Source Voltage**



**Figure 6: Body-Diode Characteristics**

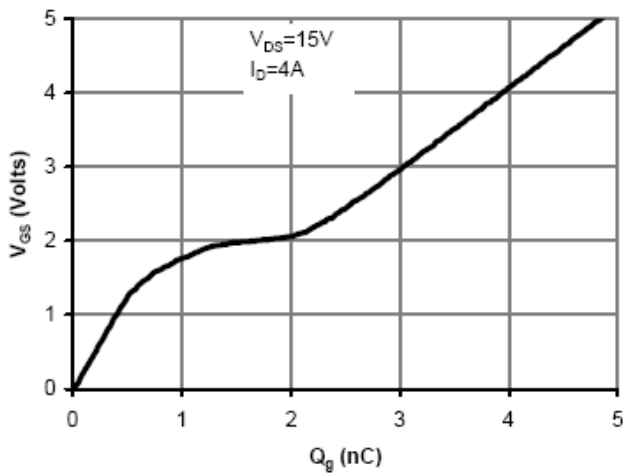


Figure 7: Gate-Charge Characteristics

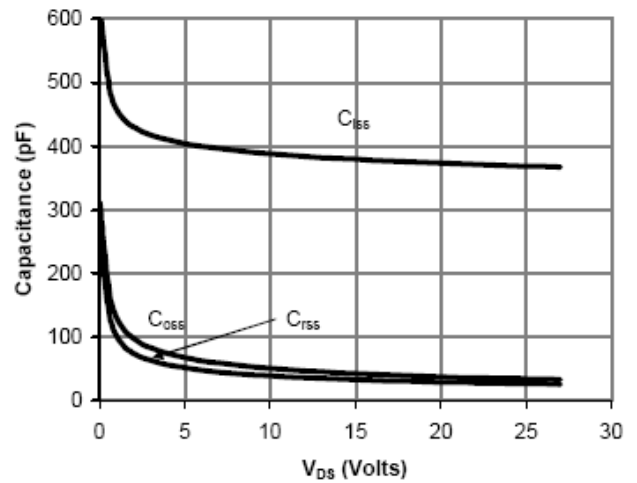


Figure 8: Capacitance Characteristics

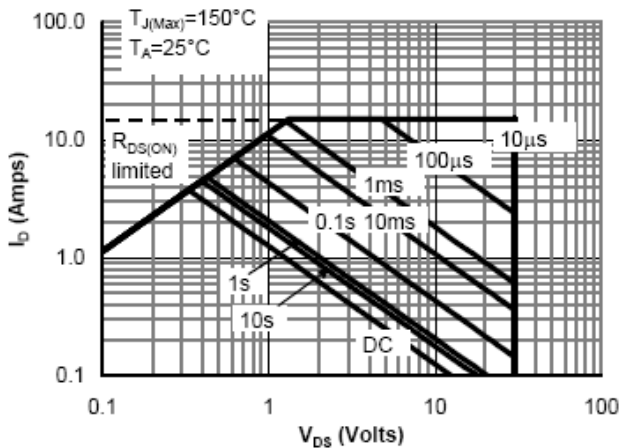


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

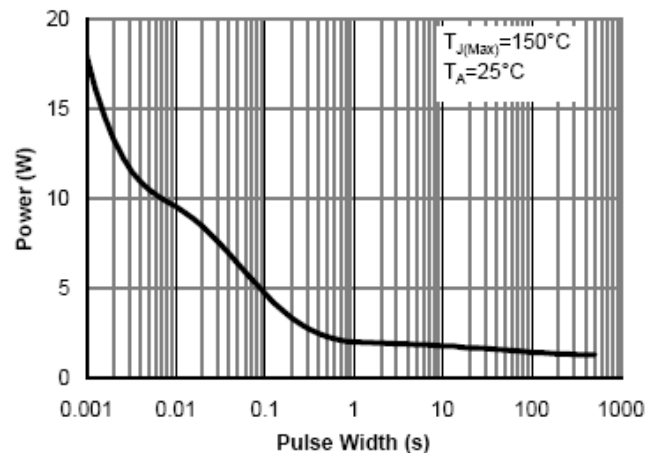


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

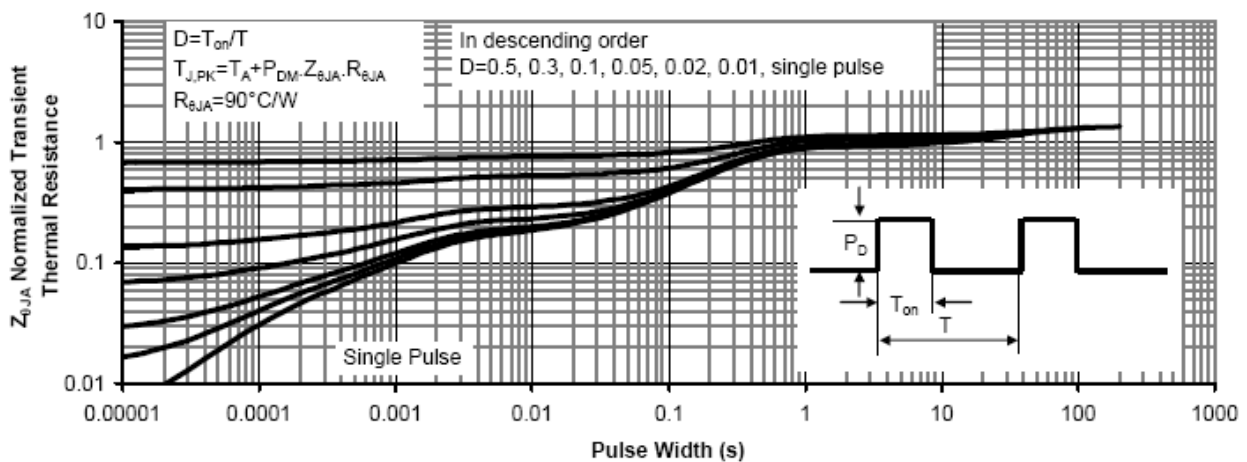


Figure 11: Normalized Maximum Transient Thermal Impedance

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